

### General Description:

The GL50N06ADDC uses advanced trench technology and design to provide excellent RDS(ON) with low gate charge. It can be used in a wide variety of applications. The package form is QFN5×6, which accords with the RoHS standard.

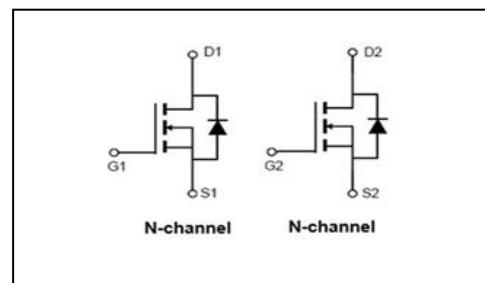
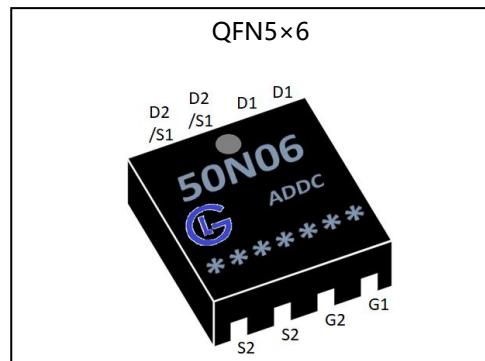
$V_{DSS}$	60	V
$I_D$	50	A
$P_D$	60	W
$R_{DS(ON)}$	11.5	$\text{m}\Omega$

### Features:

- Fast Switching
- Low Gate Charge and Rdson
- Low Reverse transfer capacitances
- 100% Single Pulse avalanche energy Test

### Applications:

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



### Absolute (Tc= 25°C unless otherwise specified):

Symbol	Parameter	Rating	Units
$V_{DSS}$	Drain-to-Source Voltage	60	V
$I_D$	Continuous Drain Current	50	A
	Continuous Drain Current $T_c = 100^\circ\text{C}$	32	A
$I_{DM}$	Pulsed Drain Current	140	A
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V
$P_D$	Power Dissipation	60	W
$T_J, T_{stg}$	Operating Junction and Storage Temperature Range	175, -55 to 175	$^\circ\text{C}$
$T_L$	Maximum Temperature for Soldering	300	$^\circ\text{C}$



# GL50N06ADDC

## GL Silicon N-Channel Power MOSFET

**Electrical Characteristics** ( $T_c = 25^\circ\text{C}$  unless otherwise specified):

OFF Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$V_{DSS}$	Drain to Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu\text{A}$	60	--	--	V
$\Delta V_{DSS}/\Delta T_J$	Bvdss Temperature Coefficient	$I_D=250\mu\text{A}, \text{Reference } 25^\circ\text{C}$	--	0.1	--	$\text{V}/^\circ\text{C}$
$I_{DSS}$	Drain to Source Leakage Current	$V_{DS}=60\text{V}, V_{GS}=0\text{V}, T_a=25^\circ\text{C}$	--	--	1	$\mu\text{A}$
		$V_{DS}=48\text{V}, V_{GS}=0\text{V}, T_a=125^\circ\text{C}$	--	--	250	
$I_{GSS(F)}$	Gate to Source Forward Leakage	$V_{GS}=+20\text{V}$	--	--	1	$\mu\text{A}$
$I_{GSS(R)}$	Gate to Source Reverse Leakage	$V_{GS}=-20\text{V}$	--	--	-1	$\mu\text{A}$

ON Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$R_{DS(ON)}$	Drain-to-Source On-Resistance	$V_{GS}=10\text{V}, I_D=20\text{A}$	--	11.5	15	$\text{m}\Omega$
$V_{GS(\text{TH})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1.0		2.5	V
Pulse width $t_p \leq 380\mu\text{s}, \delta \leq 2\%$						

Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$g_{fs}$	Forward Transconductance	$V_{DS}=5\text{V}, I_D=9\text{A}$	25	--	--	S
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=30\text{V}$	--	218 0	--	$\text{pF}$
$C_{oss}$	Output Capacitance	$f=1.0\text{MHz}$	--	350	--	
$C_{rss}$	Reverse Transfer Capacitance		--	270	--	

Resistive Switching Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$t_{d(ON)}$	Turn-on Delay Time	$R_L=1\Omega, V_{DD}=30\text{V}$	--	8.5	--	ns
$t_r$	Rise Time		--	6	--	
$t_{d(OFF)}$	Turn-Off Delay Time		--	30	--	
$t_f$	Fall Time		--	5	--	
$Q_g$	Total Gate Charge	$I_D=20\text{A}, V_{DD}=30\text{V}$	--	58	--	nC
$Q_{gs}$	Gate to Source Charge		--	8	--	
$Q_{gd}$	Gate to Drain ( "Miller" )Charge		--	17	--	

**Source-Drain Diode Characteristics**

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$I_S$	Continuous Source Current (Body Diode)		--	--	50	A
$I_{SM}$	Maximum Pulsed Current (Body Diode)		--	--	140	A
$V_{SD}$	Diode Forward Voltage	$I_S=12A, V_{GS}=0V$	--	--	1.2	V
$t_{rr}$	Reverse Recovery Time	$I_S=10A, T_j = 25^\circ C$	--	30	--	ns
$Q_{rr}$	Reverse Recovery Charge	$dI_F/dt=100A/\mu s, V_{GS}=0V$	--	44	--	nC

 Pulse width  $t_p \leq 380\mu s, \delta \leq 2\%$ 

Symbol	Parameter	Typ.	Units
$R_{\theta JC}$	Junction-to-Case	3.58	°C/W

<sup>a1</sup>: Repetitive rating; pulse width limited by maximum junction temperature

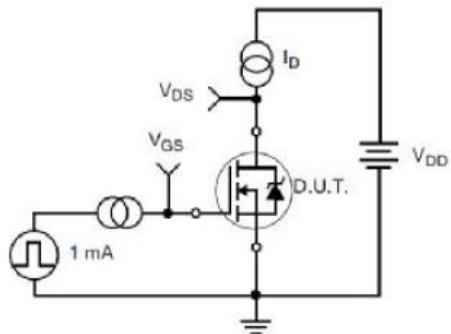
**Test Circuit and Waveform**


Figure 17. Gate Charge Test Circuit

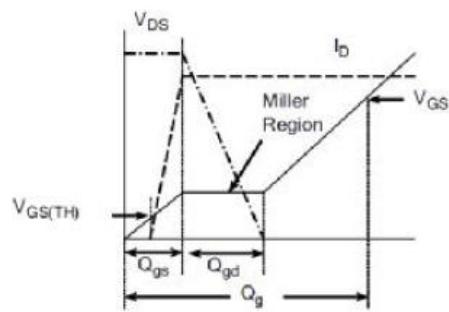


Figure 18. Gate Charge Waveform

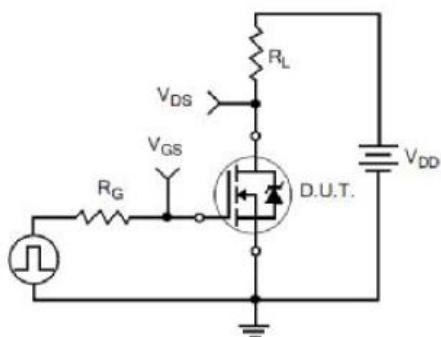


Figure 19. Resistive Switching Test Circuit

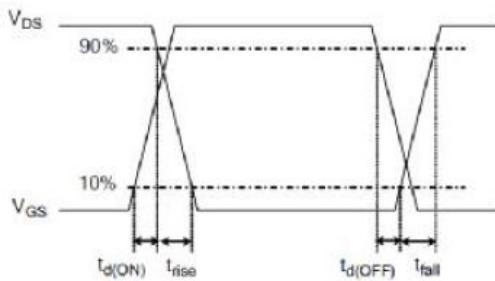
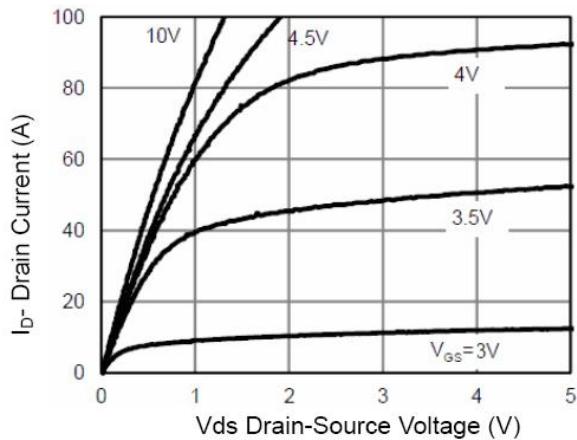
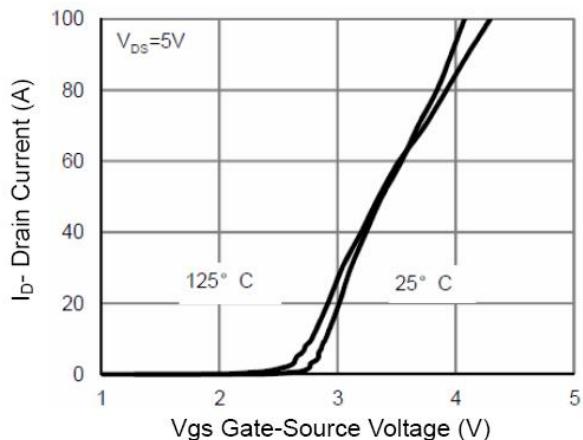
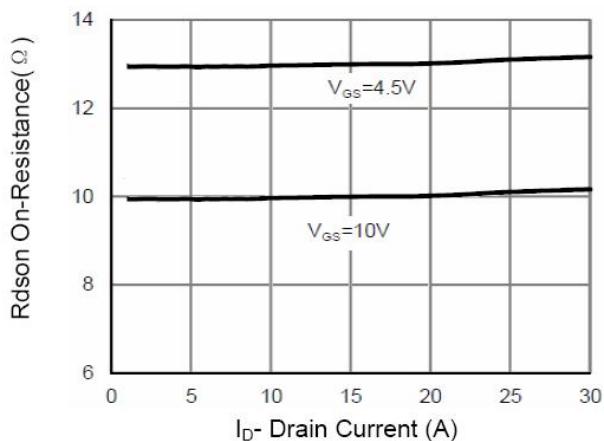
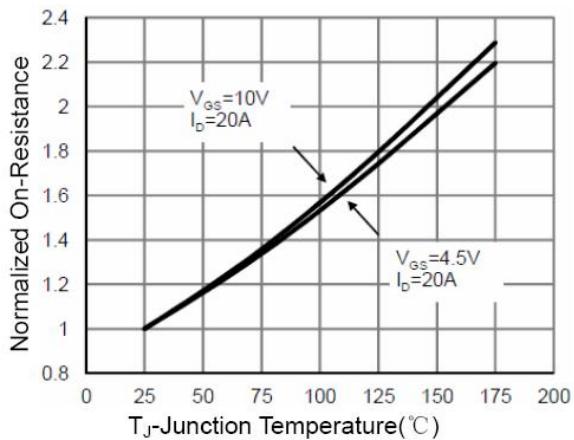
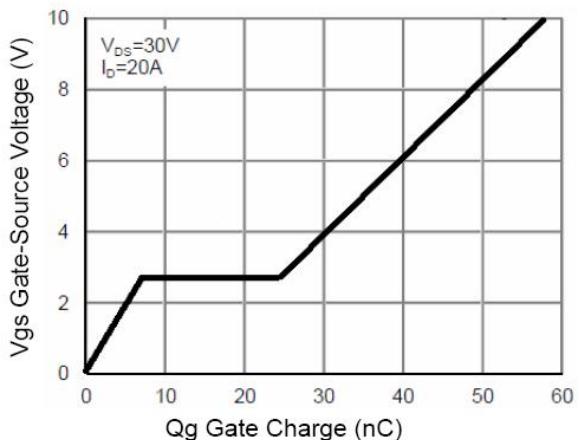
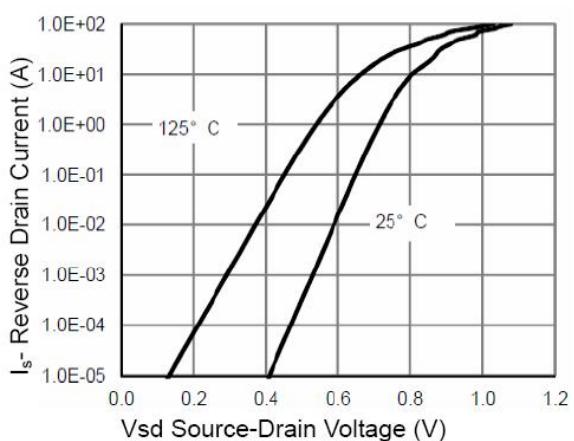


Figure 20. Resistive Switching Waveforms

**Characteristics Curve:**

**Figure 1 Output Characteristics**

**Figure 2 Transfer Characteristics**

**Figure 3 Rdson- Drain Current**

**Figure 4 Rdson-JunctionTemperature**

**Figure 5 Gate Charge**

**Figure 6 Source- Drain Diode Forward**

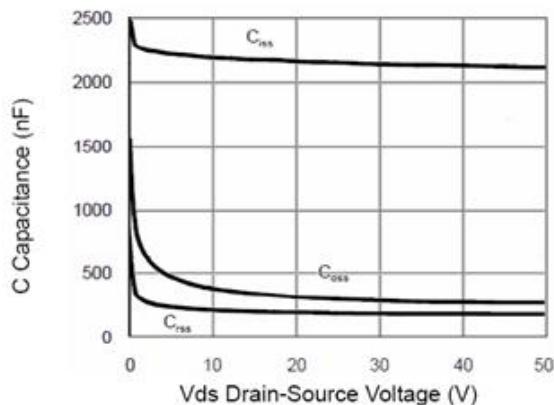


Figure 7 Capacitance vs Vds

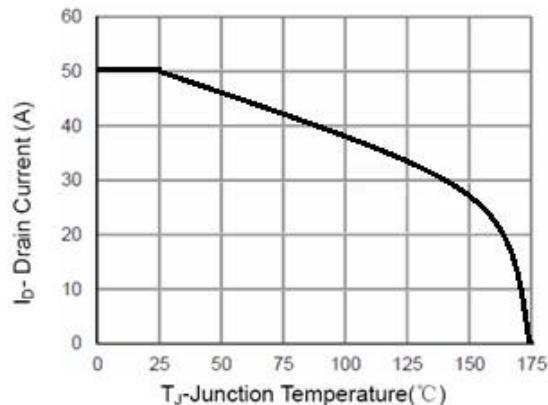


Figure 9 Current De-rating

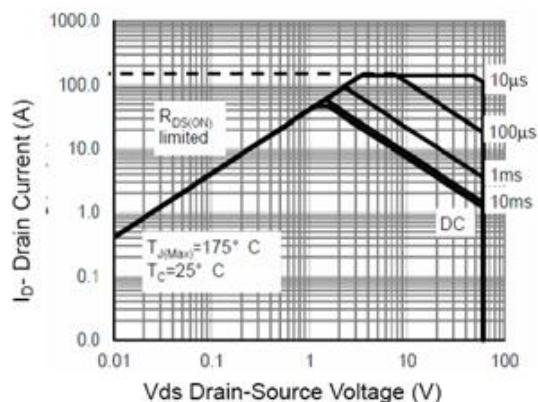


Figure 8 Safe Operation Area

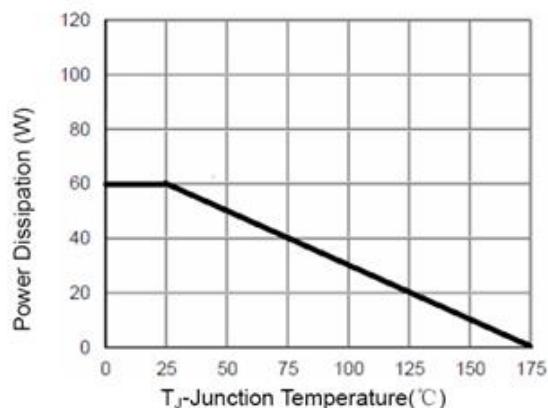


Figure 10 Power De-rating

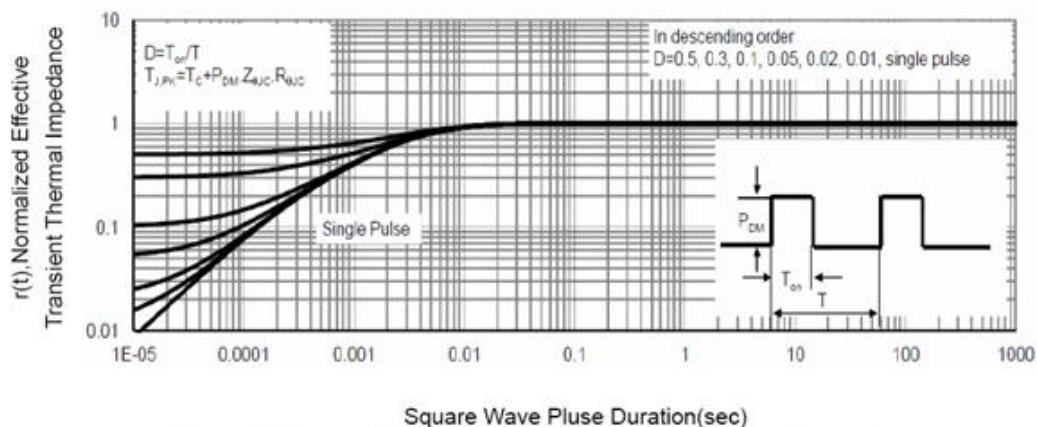


Figure 11 Normalized Maximum Transient Thermal Impedance